# imall

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### AK6420A / 40A / 80A

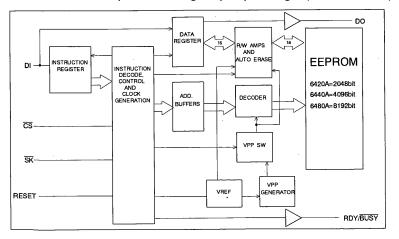
2K / 4K / 8Kbit Serial CMOS EEPROM

#### Features

- ADVANCED CMOS EEPROM TECHNOLOGY
   Wide Vcc (1.8V ~ 5.5V) operation
  - □ AK6420A · · 2048 bits: 128 × 16 organization AK6440A · · 4096 bits: 256 × 16 organization AK6480A · · 8192 bits: 512 × 16 organization
  - ONE CHIP MICROCOMPUTER INTERFACE
     Interface with one chip microcomputer's serial communication port directly
  - □ LOW POWER CONSUMPTION
    - 0.75mA Max (Read operation)
    - 0.8µA Max (Standby mode)

HIGH RELIABILITY
 Endurance : 100K cycles
 Data Retention : 10 years

- □ SPECIAL FEATURES
  - High speed operation (fMAX=1MHz: Vcc=2.5V)
  - Automatic write cycle time-out with auto-ERASE
  - Automatic address increment (READ)
  - Ready/Busy status signal
  - Software and Hardware controlled write protection
- IDEAL FOR LOW DENSITY DATA STORAGE
   Low cost, space saving, 8-pin package (SOP, SSOP)



Block diagram

#### **General Description**

The AK6420A/40A/80A is a 2048/4096/8192bit, serial, read/write, non-volatile memory device fabricated using an advanced CMOS EEPROM technology. The AK6420A has 2048bits of memory organized into 128 registers of 16 bits each. The AK6440A has 4096bits of memory organized into 256 registers of 16 bits each. The AK6440A has 8192bits of memory organized into 512 registers of 16 bits each. The AK6420A/40A/80A can operate full function under wide operating voltage range from 1.8V to 5.5V. The charge up circuit is integrated for high voltage generation that is used for write operation.

The AK6420A/40A/80A can connect to the serial communication port of popular one chip microcomputer directly (3 line negative clock synchronous interface). At write operation, AK6420A/40A/80A takes in the write data from data input pin (DI) to a register synchronously with rising edge of input pulse of serial clock pin  $(\overline{SK})$ . And at read operation, AK6420A/40A/80A takes out the read data from a register to data output pin (DO) synchronously with falling edge of  $\overline{SK}$ .

The AK6420A/40A/80A has 4 instructions such as READ, WRITE, WREN (write enable) and WRDS (write disable). Each instruction is organized by op-code block (8bits), address block (8bits) and data (8bits  $\times$  2). When input level of SK pin is high level and input level of chip select ( $\overline{CS}$ ) pin is changed from high level to low level, AK6420A/40A/80A can receive the instructions.

Special features of the AK6420A/40A/80A include : automatic write time-out with auto-ERASE, Ready/ $\overline{\text{Busy}}$  status signal output and ultra-low standby power mode when deselected ( $\overline{\text{CS}}$ =high).

• Software and Hardware controlled write protection

The AK6420A/40A/80A has 2 (hardware and software) write protection functions.

After power on or after execution of WRDS (write disable) instruction, execution of WRITE instruction will be disabled. This write protection condition continues until WREN instruction is executed or Vcc is removed from the part. Execution of READ instruction is independent of both WREN and WRDS instructions.

Reset pin should be low level when WRITE instruction is executed. When the Reset pin is high level, the WRITE instruction is not executed.

#### • Ready/Busy status signal

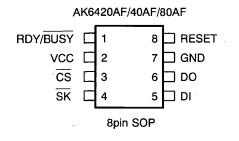
During the automatic write time-out period (BUSY status), the AK6420A/40A/80A can't accept the other instructions. The AK6420A/40A/80A has 2 functions to know the Busy status from exterior.

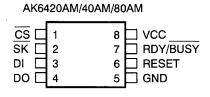
The RDY/BUSY pin indicates the Busy status regardless of the  $\overline{CS}$  pin status. The RDY/BUSY pin outputs the low level regardless of the  $\overline{CS}$  pin status during Busy status. Except the above status, this pin outputs high level. Also the DO pin indicates the Busy status. When input level of  $\overline{SK}$  pin is low level and input level of  $\overline{CS}$  pin is changed from high level, the AK6420A/40A/80A is in the status output mode and the DO pin indicates the Ready/Busy status. The Ready/Busy status outputs on DO pin until  $\overline{CS}$  pin is changed from low level to high level, or first bit ("1") of op-code of next instruction is given to the part. Except when the device is in the status output mode or outputs data, the DO pin is in the high impedance state.

Model	Memory size	Temp.Range	Vcc	Package
AK6420AF	2Kbits	-40°C~85°C	1.8V ~ 5.5V	8pin Plastic SOP
AK6420AM		-40°C~85°C	1.8V ~ 5.5V	8pin Plastic SSOP
AK6440AF	4Kbits	-40°C~85°C	1.8V ~ 5.5V	8pin Plastic SOP
AK6440AM		-40°C~85°C	1.8V ~ 5.5V	8pin Plastic SSOP
AK6480AF	8Kbits	-40°C~85°C	1.8V ~ 5.5V	8pin Plastic SOP
AK6480AM		-40°C~85°C	1.8V ~ 5.5V	8pin Plastic SSOP

#### ■ Type of Products

#### Pin arrangement







#### Pin Function

RDY/BUSY	0
/cc	
CS	Ι
SK	Ι
וכ	Ι
00	0
GND	
RESET	1
	/cc CS SK DI DI DO GND

I : Input pin

O: Output pin

#### Pin Description

#### CS (Chip Select)

When  $\overline{SK}$  is high level and  $\overline{CS}$  is changed from high level to low level, AK6420A/40A/80A can receive the instructions.  $\overline{CS}$  should be kept low level while receiving op-code, address and data and while outputting data. If  $\overline{CS}$  is changed to high level during the above period, AK6420A/40A/80A stops the instruction execution. When  $\overline{SK}$  is low and  $\overline{CS}$  is changed from high level to low level, AK6420A/40A/80A will be in status output mode. The  $\overline{CS}$  need not be low level during the automatic write time-out period (BUSY status).

#### **SK** (Serial Clock)

The  $\overline{SK}$  clock pin is the synchronous clock input for input/output data. At write operation, AK6420A/40A/80A takes in the write data from data input pin (DI) synchronously with rising edge of input pulse of serial clock pin ( $\overline{SK}$ ). And at read operation, AK6420A/40A/80A takes out the read data to data output pin (DO) synchronously with falling edge of  $\overline{SK}$ . The  $\overline{SK}$  clock is not needed during the automatic write time-out period ( $\overline{BUSY}$  status), the status output period and when the device isn't selected ( $\overline{CS}$  = high level).

#### DI (Data Input)

The op-code, address and write data is input to the DI pin.

#### DO (Data Output)

The DO pin outputs the read data and status signal and will be high impedance except for this timing.

#### RDY/BUSY (Ready/Busy status)

This pin outputs the internal programming status. When the AK6420A/40A/80A is in the automatic write timeout period, this pin outputs the low level (BUSY status), and outputs the high level except for this timing.

#### **RESET** (Reset)

The AK6420A/40A/80A stops executing the write instruction when the RESET pin is high level. The RESET pin should be low level while the write instruction input period and the automatic write time-out period. If the RESET pin is high level while the automatic write time-out period, the AK6420A/40A/80A stops execution of internal programming and the device returns to ready status. In this case the word data of the specified address will be incomplete. When inputting the new instruction after RESET, the  $\overline{CS}$  should be set to high level. The read, write enable and write disable instructions are not affected by RESET pin status.

Vcc (Power Supply)

GND (Ground)

#### **Functional Description**

The AK6420A/40A/80A has 4 instructions such as READ, WRITE, WREN (write enable) and WRDS (write disable). Each instruction is organized by op-code block (8bits), address block (8bits) and data (8bits  $\times$  2). When input level of  $\overline{SK}$  pin is high level and input level of chip select ( $\overline{CS}$ ) pin is changed from high level to low level, AK6420A/40A/80A can receive the instructions.

When the instructions are executed consecutively, the  $\overline{CS}$  pin should be brought to high level for a minimum of 250ns(Tcs) between consecutive instruction cycle.

#### ■ Instruction Set For 6420A

Instruction	Op-Code	Address	Data
READ	10101000	A6 A5 A4 A3 A2 A1 A0 0	D15 -D0
WRITE	10100100	A6 A5 A4 A3 A2 A1 A0 0	D15 -D0
WREN	10100011	* * * * * * * * *	
WRDS	10100000	* * * * * * * * *	
(WRAL)	10101111	* * * * * * * *	D15 -D0

#### ■ Instruction Set For 6440A

Instruction	Op-Code	Address	Data
READ	10101000	A7 A6 A5 A4 A3 A2 A1 A0	D15 -D0
WRITE	10100100	A7 A6 A5 A4 A3 A2 A1 A0	D15 -D0
WREN	10100011	* * * * * * * * *	
WRDS	10100000	* * * * * * * * *	
(WRAL)	10101111	* * * * * * * *	D15 -D0

#### ■ Instruction Set For 6480A

Instruction	Op-Code	Address	Data
READ	1010100A8	A7 A6 A5 A4 A3 A2 A1 A0	D15 -D0
WRITE	1010010A8	A7 A6 A5 A4 A3 A2 A1 A0	D15 -D0
WREN	10100011	* * * * * * * * *	
WRDS	10100000	* * * * * * * * *	
(WRAL)	10101111	* * * * * * * *	D15 -D0

#### ×:don't care

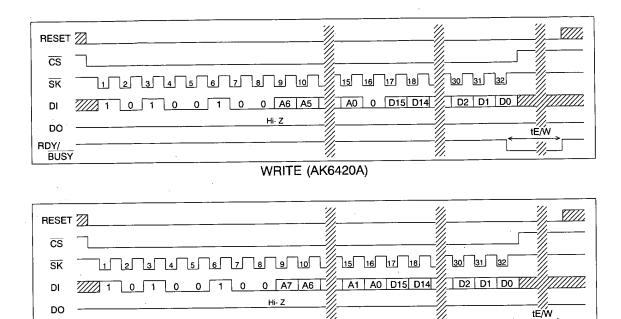
(Note) The WRAL instruction is used for factory function test only. User can't use this instruction .

#### ASAHI KASEI

#### Write

The write instruction is followed by 16 bits of data to be written into the specified address. After the 32nd rising edge of  $\overline{SK}$  to read D0 in, the AK6420A/40A/80A will be put into the automatic write time-out period. During the automatic write time-out period (Busy status) and while entering write instruction, the RESET pin should be low level. If the RESET pin is set to high level during the automatic write time-out period, the AK6420A/40A/80A stops execution of internal programming and the device returns to ready status. In this case the word data of the specified address will be incomplete. When inputting the new instruction after RESET, the  $\overline{CS}$  should be set to high level. When the RESET pin is kept at high level, the write is not executed. This becomes write protection function.

The  $\overline{\text{CS}}$  pin need not be high level during automatic write time-out period ( $\overline{\text{BUSY}}$  status).



#### WRITE (AK6440A)

SK 12	
DI 201	
DO	Hi-Z
RDY/ BUSY	

#### WRITE (AK6480A)

RDY/ BUSY

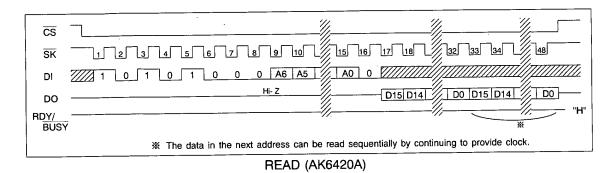
#### ASAHI KASEI

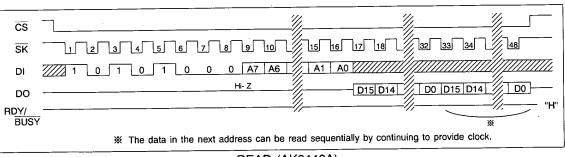
#### Read

The read instruction is the only instruction which outputs serial data on the DO pin. When the 17th falling edge of  $\overline{SK}$  is received, the DO pin will come out of high impedance state and shift out the data from D15 first in descending order which is located at the address specified in the instruction.

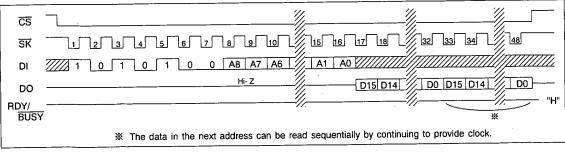
The data in the next address can be read sequentially by continuing to provide clock. The address automatically cycles to the next higher address after the 16bit data shifted out.

- AK6420A • When the highest address is reached (\$7F), the address counter rolls over to address \$00 allowing the read cycle to be continued indefinitely.
- AK6440A • When the highest address is reached (\$FF), the address counter rolls over to address \$00 allowing the read cycle to be continued indefinitely.
- AK6480A • When the highest address is reached (\$1FF), the address counter rolls over to address \$000 allowing the read cycle to be continued indefinitely.





#### READ (AK6440A)





#### ASAHI KASEI

#### WREN / WRDS ( Write Enable and Write Disable )

When Vcc is applied to the part, it powers up in the programming disable (WRDS) state. Programming must be preceded by a programming enable (WREN) instruction. Programming remains enabled until a programming disable (WRDS) instruction is executed or Vcc is removed from the part. The programming disable instruction is provided to protect against accidental data disturb. Execution of a read instruction is not affected by both WREN and WRDS instructions.

CS	//////////////
SK	
DI	1     0     0     X     X     X     X     X     X       WHEN=11 WHDS=00     HLZ
DO	WHDS=00 Hi-Z
	※ SK pulses exceeding 17 are ignored.
	WREN / WRDS (AK6420A/40A/80A)

#### Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Power Supply	VCC	-0.6	+7.0	V
All Input Voltages with Respect to Ground	VIO	-0.6	VCC+0.6	V
Ambient storage temperature	Tst	-65	+150	°C

Stress above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum conditions for extended periods may affect device reliability.

#### **Recommended Operating Condition**

Parameter	Symbol	Min	Max	Unit
Power Supply	VCC	1.8	5.5	V
Ambient Operating Temperature	Та	-40	+85	°C

#### **Electrical Characteristics**

#### (1) D.C. ELECTRICAL CHARACTERISTICS

(  $1.8V{\le}Vcc{\le}5.5V\!,\,{-}40^\circC{\le}Ta{\le}85^\circC\!,$  unless otherwise specified )

Parameter	Symbol	Cond	ition	Min.	Max.	Unit
Current Dissipation	ICC1	VCC=5.5V, tSł	<p=500ns, *1<="" td=""><td></td><td>4.0</td><td>mA</td></p=500ns,>		4.0	mA
(WRITE)	ICC2	VCC=2.5V, *1	6420A		2.0	mA
,		tSKP=500ns	6440A/80A		2.5	mA
	ICC3	VCC=1.8V, *1	6420A		1.5	mA
		tSKP=1.5us	6440A/80A		2.0	mA
Current Dissipation	ICC4	VCC=5.5V, tSł	<p=500ns, *1<="" td=""><td></td><td>0.75</td><td>mA</td></p=500ns,>		0.75	mA
(READ,WREN, WRDS)	ICC5	VCC=2.5V, tSł	<p=500ns, *1<="" td=""><td></td><td>0.3</td><td>mA</td></p=500ns,>		0.3	mA
,	ICC6	VCC=1.8V, tSł	<p=1.5us, *1<="" td=""><td></td><td>0.15</td><td>mA</td></p=1.5us,>		0.15	mA
Current Dissipation (Standby)	ICCSB	VCC=5.5V	*2		0.8	uA
Input High Voltage1 CS, SK, RESET pin	VIH1	1.8V≤VCC≤5.5	1.8V≤VCC≤5.5V		VCC+0.5	V
Input High Voltage2	VIH2	2.5V≤VCC≤5.5V		$0.7 \times VCC$	VCC+0.5	V
DI pin	VIH3	1.8V≤VCC<2.5V		$0.8 \times VCC$	VCC+0.5	V
Input Low Voltage1 CS, SK, RESET pin	VIL1	1.8V≤VCC≤5.5V		0	0.2×VCC	V
Input Low Voltage2	VIL2	2.5V≤VCC≤5.5	5V	0	$0.3 \times VCC$	V
DI pin	VIL3	1.8V≤VCC<2.5	5V	0	$0.2 \times VCC$	V
Output High Voltage	VOH1	2.5V≤VCC≤5.5V IOH=-50μA		VCC-0.3		V
	VOH2	1.8V≤VCC<2.5 IOH=-50μA	5V	VCC-0.3		V
Output Low Voltage	VOL1	2.5V≤VCC≤5.5 IOL=1.0mA	5V		0.4	V
	VOL2	1.8V≤VCC<2.5V IOL=0.1mA			0.4	V
Input Leakage	ILI	VCC=5.5V,VIN=5.5V			±1.0	uA
Output Leakage	ILO	VCC=5.5V VOUT=5.5V, 0	s=vcc		±1.0	uA

\*1: VIN=VIH/VIL,DO=RDY/BUSY=Open

\*2: CS=Vcc, SK/DI/RESET=Vcc/GND,DO=RDY/BUSY=Open

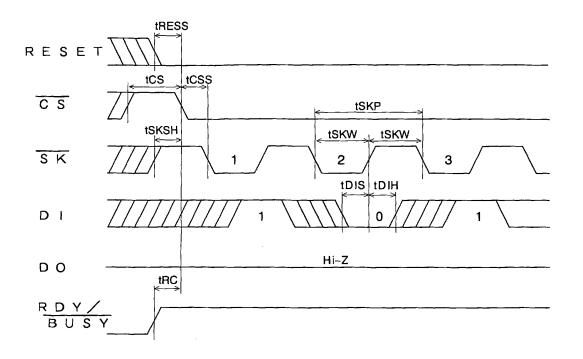
#### (2) A.C. ELECTRICAL CHARACTERISTICS

#### ( $1.8V{\leq}Vcc{\leq}5.5V\!,\,{-}40^\circC{\leq}Ta{\leq}85^\circC\!,$ unless otherwise specified )

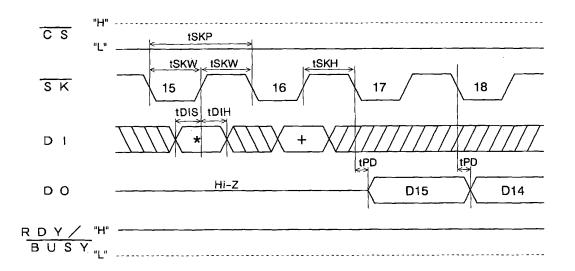
Parameter	Symbol	Condition	Min.	Max.	Unit
SK Cycle Time	tSKP1	2.5V≤VCC≤5.5V	500		ns
	tSKP2	1.8V≤VCC<2.5V	1.5		us
SK Pulse Width	tSKW1	2.5V≤VCC≤5.5V	250		ns
	tSKW2	1.8V≤VCC<2.5V	750		ns
SK High Pulse Width	tSKH1	4.5V≤VCC≤5.5V	250		ns
	tSKH2	2.5V≤VCC<4.5V	500		ns
*3	tSKH3	1.8V≤VCC<2.5V	750		ns
CS Setup Time	tCSS		100		ns
CS Hold Time	tCSH		100		ns
SK Setup Time	tSKSH /tSKSL		100		ns
RESET Setup Time	tRESS		0		ns
RESET Hold Time	tRESH		0		ns
Data Setup Time	tDIS1	4.5V≤VCC≤5.5V	100		ns
	tDIS2	1.8V≤VCC<4.5V	200		ns
Data Hold Time	tDIH1	4.5V≤VCC≤5.5V	100		ns
	tDIH2	1.8V≤VCC<4.5V	200		ns
DO pin	tPD1	4.5V≤VCC≤5.5V, *4		150	ns
Output delay	tPD2	2.5V≤VCC<4.5V, *4		300	ns
	tPD3	1.8V≤VCC<2.5V. *4		500	ns
RDY/BUSY pin	tPD	CL=100pF		1	us
Output delay					
Selftimed Programming	tE/W			10	ms
Time					
Write Recovery Time	tRC		100		ns
Min $\overline{\text{CS}}$ High Time	tCS		250		ns
DO High-Z Time	tOZ			500	ns

\*3: tSKH is the high pulse width of 16th SK pulse in READ operation. When the data in the next address are read sequentially by continuing to provide clock, tSKH are applied to the high pulse width of 32nd and 48th (multiple of 16) SK pulse in READ operation.
\*4: CL=100pF

#### Synchronous Data Timing

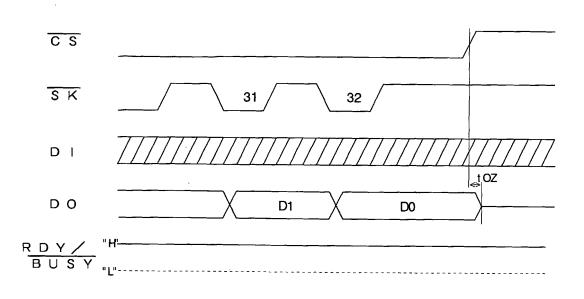


#### Instruction Input

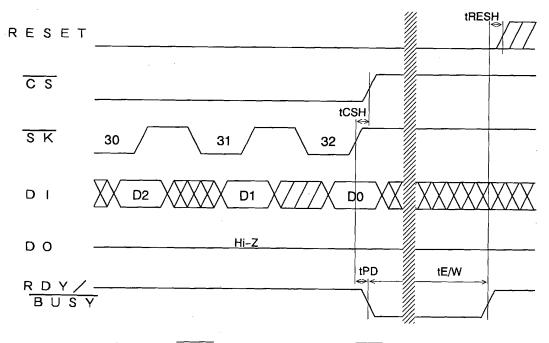


(note) \* = "A0" for AK6420A, "A1" for AK6440A/80A + = "0" for AK6420A, "A0" for AK6440A/80A

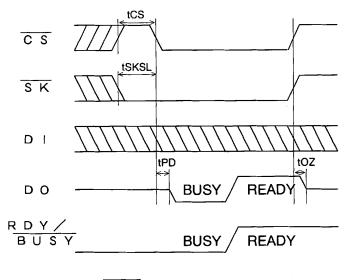
Data Output (READ)



Data Output (READ)



Ready / BUSY Signal Output (RDY/BUSY pin)



Ready / BUSY Signal Output ( DO pin )

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